



## APPENDIX

## Changes to Abstract:

The following is a marked-up version of the amended Abstract.

ABSTRACT

In a flexible printed wiring board 10 obtained by connecting metal bumps 1a of a first flexible printed wiring part 1 and connection pads 2a of a second flexible printed wiring part 2, the first flexible printed wiring part 1 is composed of a conductive layer 4 and insulating layer 5 adjacent thereto, holes A being provided in the insulating layer 5 so as to reach the conductive layer 4, metal plugs 6 being formed in these holes A by an electrolytic plating method, metal bumps 1a being produced by making the tips of these metal plugs 6 project from the insulating layer 5. In this way, as many as possible flexible printed wiring boards can be obtained from a laminated sheet for flexible printed wiring of prescribed size.